

Vishay Siliconix

Dual N-Channel 30 V (D-S) MOSFET

PRODU	CT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A)	Q _g (Typ.)	
30	0.650 at V _{GS} = 10 V	0.48	0.5	
30	0.770 at V _{GS} = 4.5 V	0.45	0.5	

FEATURES

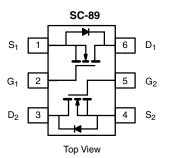
- TrenchFET[®] Power MOSFET
- ESD Protected: 550 V Typical HBM
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

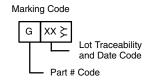
BENEFITS

- Low Offset Voltage
- Low-Voltage Operation
- **High-Speed Circuits** •
- Small Board Area

APPLICATIONS

- Load/Signal Switching for Portable Devices
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems •





Ordering Information: Si1028X-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	S (T _A = 25 °C, un	less otherwise	noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T 150 °C) ⁸	T _A = 25 °C	I-	0.48 ^{a, b}		
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T _A = 70 °C	D ID	0.45 ^{a, b}	A	
Pulsed Drain Current (t = 300 µs)	·	I _{DM}	1		
Continuous Source-Drain Diode Current	T _A = 25 °C	ا _S	0.18 ^{a, b}	A	
	T _A = 25 °C	P _D	0.22 ^{a, b}	w	
Maximum Power Dissipation ^a	T _A = 70 °C		0.14 ^{a, b}	vv	
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Тур.	Max.	Unit
Maximum Junction-to-Ambient ^b	t ≤ 5 s	R _{thJA}	470	565	°C/W
	Steady State	• ·tnJA	560	675	0,11

Notes:

a. Surface mounted on 1" x 1" FR4 board.

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RoHS COMPLIANT HALOGEN FREE

b. t = 5 s.

Si1028X

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		33		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 2.8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		2.5	V	
Cata Caura Laskana		$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 20		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 1		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	V_{DS} = \geq 5 V, V_{GS} = 10 V	1			Α	
	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		0.540	0.650	-	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 0.2 A		0.640	0.770	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 10 \text{ V}, I_{D} = 0.5 \text{ A}$		1		S	
Dynamic ^b				•	1		
Input Capacitance	C _{iss}			16			
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		8		pF	
Reverse Transfer Capacitance	C _{rss}			4			
Total Cata Charge		$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		1	2		
Total Gate Charge	Qg			0.5	1	20	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 0.5 \text{ A}$		0.15		nC	
Gate-Drain Charge	Q _{gd}			0.20			
Gate Resistance	Rg	f = 1 MHz		50		Ω	
Turn-On Delay Time	t _{d(on)}			8	16		
Rise Time	t _r	V_{DD} = 15 V, R_L = 37.5 Ω		10	20		
Turn-Off Delay Time	t _{d(off)}	I_{D} = 0.38 A, V_{GEN} = 4.5 V, R_{g} = 1 Ω		9	18		
Fall Time	t _f			8	16		
Turn-On Delay Time	t _{d(on)}			2	4	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 37.5 Ω		9	18		
Turn-Off Delay Time	t _{d(off)}	${ m I}_{ m D}$ = 0.38 A, ${ m V}_{ m GEN}$ = 10 V, ${ m R}_{ m g}$ = 1 Ω		7	14	-	
Fall Time	t _f	1		8	16		
Drain-Source Body Diode Characterist	ics						
Pulse Diode Forward Current ^a	I _{SM}				1	А	
Body Diode Voltage	V _{SD}	I _S = 0.38 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			9	18	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{-} = 0.38 \text{ A} \text{ d}/\text{d}t = 100 \text{ A}/\text{up}$		2	4	nC	
Reverse Recovery Fall Time	t _a	l _F = 0.38 A, dl/dt = 100 A/μs		5		ns	
Reverse Recovery Rise Time	t _b			4			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

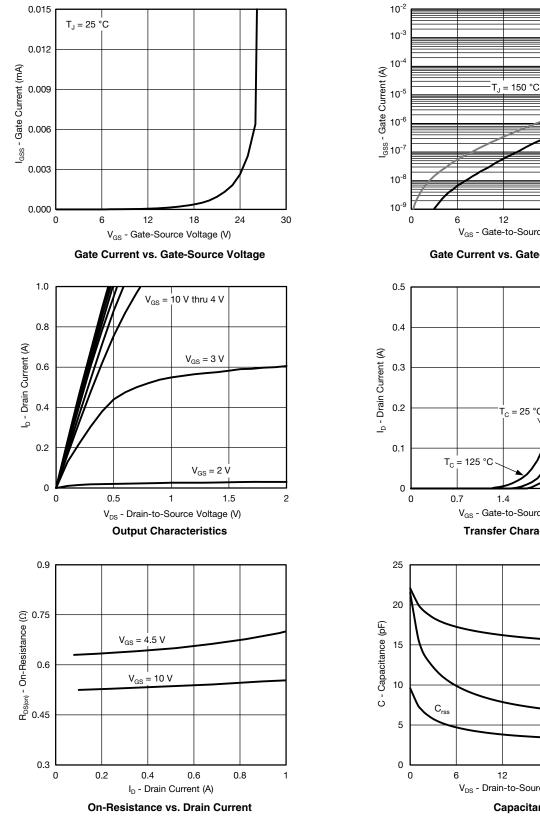
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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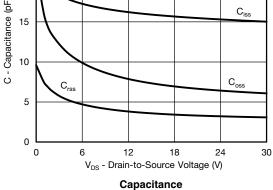
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



= 25 °C 24 30 12 18 - Gate-to-Source Voltage (V) Gate Current vs. Gate-Source Voltage 25 $T_{C} =$ - 55 °C 2.8 1.4 2.1 3.5 V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



Document Number: 63862 S12-1956-Rev. B, 13-Aug-12 For technical questions, contact: pmostechsupport@vishay.com

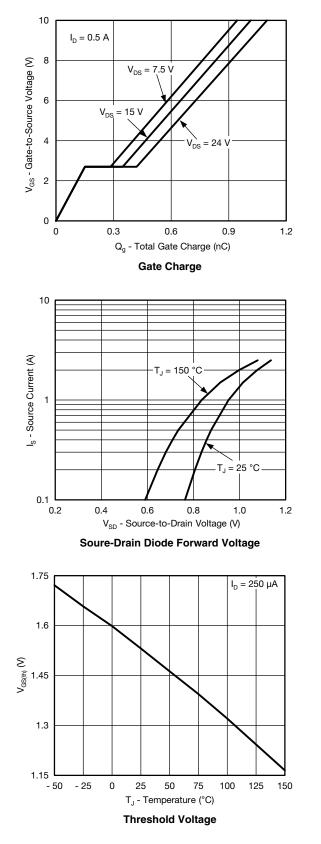
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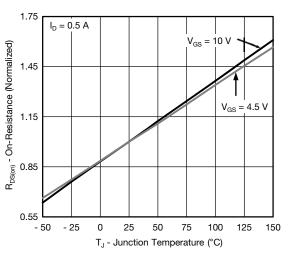
Si1028X

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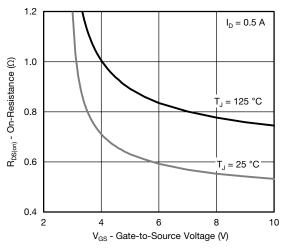


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

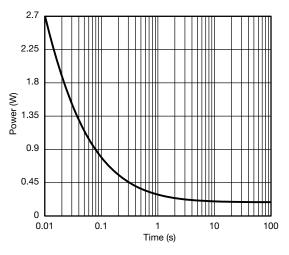




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

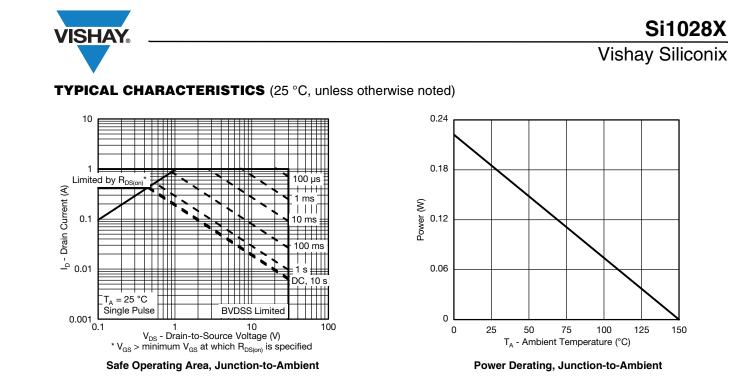


Single Pulse Power, Junction-to-Ambient

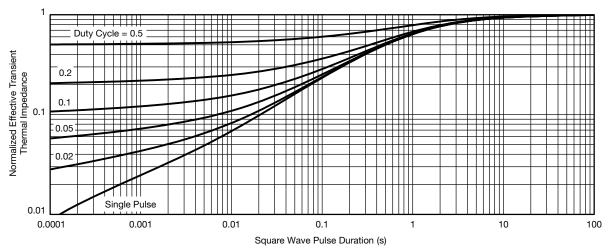
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* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Ambient

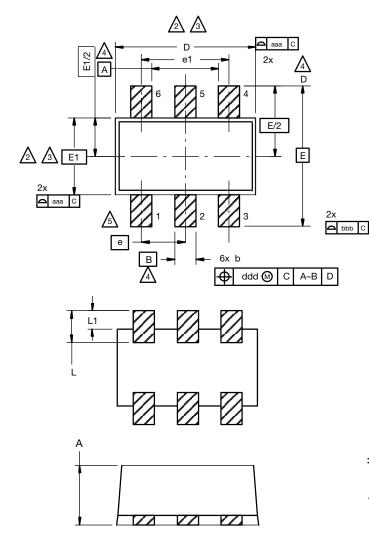
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Vishay Siliconix

SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

A Datums A, B and D to be determined 0.10 mm from the lead tip.

 \triangle Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS				
	MIN.	NOM.	MAX.		
А	0.56	0.58	0.60		
A1	0	0.02	0.10		
b	0.15	0.22	0.30		
С	0.10	0.14	0.18		
D	1.50	1.60	1.70		
E	1.50	1.60	1.70		
E1	1.15	1.20	1.25		
е	0.45	0.50	0.55		
e1	0.95	1.00	1.05		
L	0.25	0.35	0.50		
L1	0.10	0.20	0.30		
C14-0439-Rev DWG: 5880	v. C, 11-Aug-14				

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

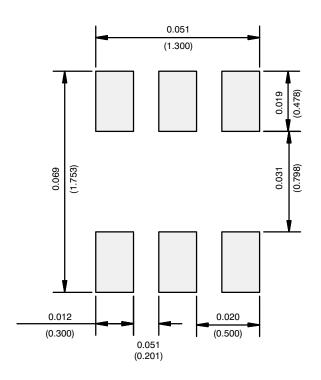
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Application Note 826

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RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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